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南威软件股份有限公司关于为控股子公司银行授信提供担保的进展公告. Includes financial data table for Q4 2024 and Q3 2025, and details of the bank credit guarantees provided to subsidiaries.

Table with 2 columns: 被担保人, 2023年12月31日(经审计), 2024年9月30日(未经审计). Lists subsidiaries and their financial metrics.

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南威软件股份有限公司董事会 2025年3月15日. Details regarding the company's financial performance, risk management, and shareholder information.

深圳市素菱实业股份有限公司关于司法拍卖的提示性公告. Details regarding the public auction of shares held by the company.

Table with 2 columns: 标的资产, 2023年12月31日(经审计), 2024年9月30日(未经审计). Lists assets and their financial metrics.

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深圳市素菱实业股份有限公司 2025年03月15日. Details regarding the company's financial performance, risk management, and shareholder information.

金禄电子科技股份有限公司关于使用暂时闲置募集资金进行现金管理的进展公告(二十六). Details regarding the company's use of idle funds for cash management.

Table with 2 columns: 序号, 标的资产, 2023年12月31日(经审计), 2024年9月30日(未经审计). Lists assets and their financial metrics.

金禄电子科技股份有限公司关于回购结果暨股份变动公告. Details regarding the company's share repurchase results and share changes.

金禄电子科技股份有限公司 2025年3月15日. Details regarding the company's financial performance, risk management, and shareholder information.

芯联集成电路制造股份有限公司关于发行股份及支付现金购买资产暨关联交易申请的审核问询回复的公告. Details regarding the company's IPO application and related transactions.

Table with 2 columns: 序号, 标的资产, 2023年12月31日(经审计), 2024年9月30日(未经审计). Lists assets and their financial metrics.

芯联集成电路制造股份有限公司 2025年3月15日. Details regarding the company's financial performance, risk management, and shareholder information.

芯联集成电路制造股份有限公司 2025年3月15日. Details regarding the company's financial performance, risk management, and shareholder information.